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JC882 U.S. PTO

No. TS01-663

Sir:



12/05/01

J1080 U.S. PTO
10/005803
12/05/01

Transmitted herewith for filing is the Patent Application of:

Inventor: HSIN-CHING SHIH, YI-NIEN SU, LI-TE S. LIN, LI-CHIE CHIAO

For: DRY-WET-DRY SOLVENT-FREE PROCESS AFTER STOP LAYER ETCH IN DUAL DAMASCENE PROCESS

Enclosed are:

- ☒ 3 sheets of drawing(s) - formal.
- ☒ An assignment of the invention to Taiwan Semiconductor Manufacturing Company
- ☐ An associate power of attorney ☐ Applicant claims small entity status
- ☒ Request & Certification under 35 USC 122(b)(2)(b)(i)

The filing fee has been calculated as shown below:

	(Col. 1)	(Col. 2)	OTHER THAN A SMALL ENTITY	
FOR:	NO. FILED	NO. EXTRA	RATE	FEE
BASIC FEE				\$ 740.
TOTAL CLAIMS	16 -20=	0	x 18 =	\$ 0.
INDEP CLAIMS	1 -3=	0	x 84 =	\$ 0.
MULTIPLE DEPENDENT CLAIM PRESENTED			+ 260 =	
SUB TOTAL				\$ 740.
ASSIGNMENT				\$40.
TOTAL				\$ 780.

- ☒ Please charge my Deposit Account No. 19-0033 in the amount of \$ 780. A duplicate copy of this sheet is enclosed.
- ☒ The Commissioner is hereby authorized to charge payment of the following fees associated with this communication or credit any overpayment to Deposit Account No. 19-0033. A duplicate copy of this sheet is enclosed.
- ☒ Any additional filing fees required under 37 CFR \$1.16.
- ☒ Any patent application processing fees under 37 CFR \$1.17.

Respectfully submitted,

STEPHEN B. ACKERMAN, REG. NO. 37,761


Under the Paperwork Reduction Act of 1995, no persons are required to respond to a collection of information unless it displays a valid OMB control number.

NONPUBLICATION REQUEST UNDER 35 U.S.C. 122(b)(2)(B)(i)	First Named Inventor	Hsin-Ching Shih
	Title	Dry-Wet-Dry Solvent-Free Process After Stop Layer Etch In Dual Nanosecond Process
	Atty Docket Number	TS01-663

I hereby certify that the invention disclosed in the attached application **has not and will not be** the subject of an application filed in another country, or under a multilateral agreement, that requires publication at eighteen months after filing.

I hereby request that the attached application not be published under 35 U.S.C. 122(b).

12/5/01
Date


Signature

Stephen B. Ackerman
Typed or printed name Reg # 37,761

This request must be signed in compliance with 37 CFR 1.33(b) and submitted with the application **upon filing**.

Applicant may rescind this nonpublication request at any time. If applicant rescinds a request that an application not be published under 35 U.S.C. 122(b), the application will be scheduled for publication at eighteen months from the earliest claimed filing date for which a benefit is claimed.

If applicant subsequently files an application directed to the invention disclosed in the attached application in another country, or under a multilateral international agreement, that requires publication of applications eighteen months after filing, the applicant **must** notify the United States Patent and Trademark Office of such filing within forty-five (45) days after the date of the filing of such foreign or international application. **Failure to do so will result in abandonment of this application (35 U.S.C. 122(b)(2)(B)(iii)).**